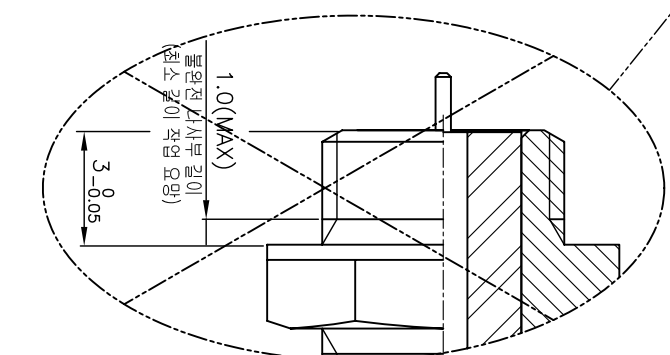
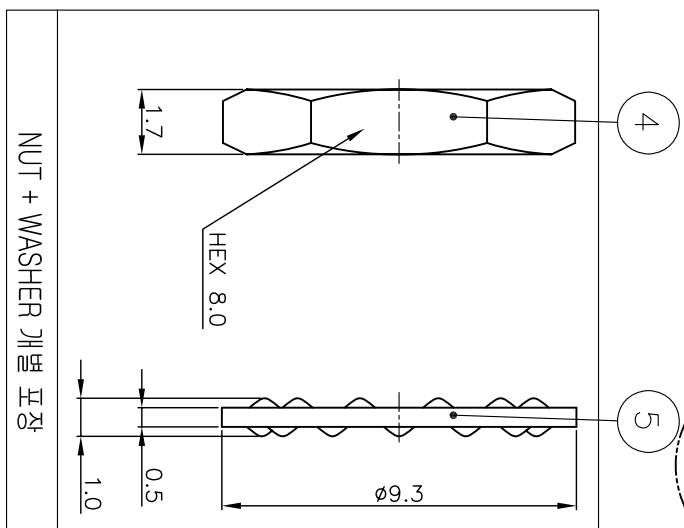
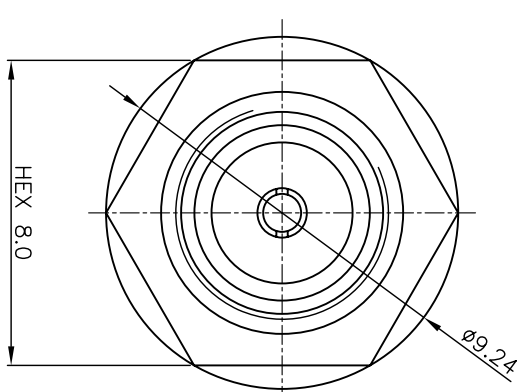
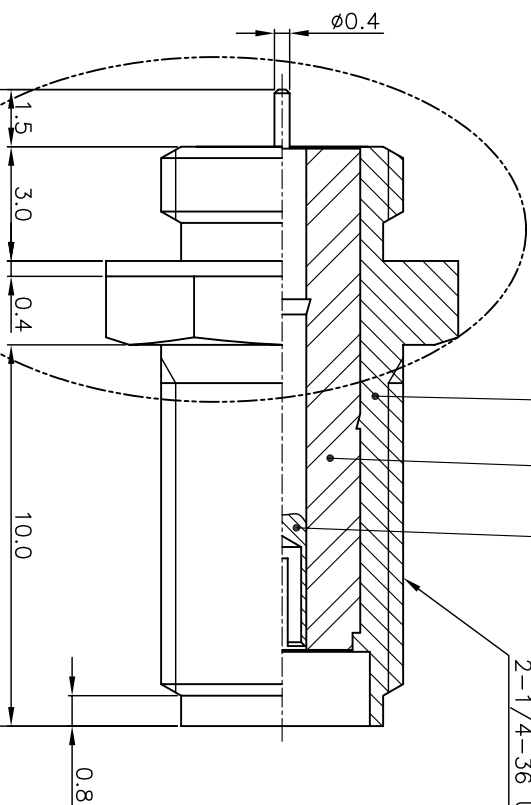


REVISION			
REV	DESCRIPTION	DRAWN	APPR
1	Initial Registration	I.C.KIM	J.H.YOUN
[설번처리(No.200911-007) 조달/성 개선 (불완전나사->완전나사 변경)]		E.H.KIM	I.C.KIM
			2012.11.27.

2-1/4-36 UNS-2A



NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
5	WASHER	1	BSS	Nickel Plate	DWA00005-5/3
4	NUT	1	MBSBD	Nickel Plate	DNT00025-5/5
3	INSULATOR	1	TEFLON		DIN01947-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT02501-5/1
1	BODY	1	MBSBD	Nickel Plate	DBD02963-5/1

Decimal	Angle	DATE	APPROVED BY	CHECKED BY	DRAWN BY	SCALE	UNIT	FINISH	TOLERANCE	MATERIAL	FINISH
±0.1	±1°	2012. 11. 27.	I.C.KIM		E.H.KIM	5/1	mm				
KJ COMTECH CO.,LTD. RF & MICROWAVE TECHNOLOGY Tel : 82-82-347-8015 Fax : 82-82-347-8017											
SMA50 SOLDER END JB (F/F) DWG NO. CN02709-7/1 REVISION 1 SHEET 1 of 1											

NUT + WASHER 개별 포장